



# Data Sheet

Customer:	
	CL-SFC281DWW-3K-90CRI
Sample No:	
Description:	2835 Warm White SMD
Item No:	

Customer				
Check	Inspection	Approval	Date	





### **Features:**

- . Reflow Solderable
- . High Luminous Intensity and Low Power Dissipation
- . Good Reliability and Long Life
- . Complied With RoHS Directive

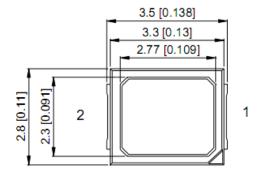


### **Technical Data Sheet**

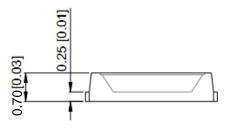
This product is generally used as indicator and luminary for electronic equipment such as household appliance, communication equipment, and dashboard.

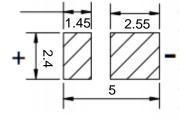
### **Applications**

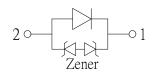
- Optical indicator
- Indoor display
- Backlighting in dashboard and switch
- Flat backlighting for LCD, symbol and display
- General use

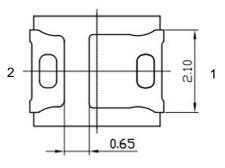












### Notes:

- 1 . All dimension units are millimeters.
- 2. All dimension tolerance is ±0.2mm unless otherwise noted.

REV NO: A/1 Page:1 of 7





### **Selection Guide**

Part No.	Dice	Lens Type	Luminous Flux(Lm) 60mA			Viewing Angle
Tare No.			Min	Тур	Max	201/2
CL-SFC281DWW-3K-90CRI	White (InGaN )	Yellow Diffused	30	31	32	120

### Note:

- 1.1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.
- 2.30 lm the following Products lumens allow differences:  $\pm 0.2 LM.$

# Electrical / Optical Characteristics at Ta=25°C

Parameter	Symbol	Min.	Тур.	Max	Units	test conditions
Forward Voltage	VF	2.6	2.8	3.0	V	IF=60mA
Reverse Current	IR			10	uA	VR = 5V
Color Rndering Index	CRI	80				IF=60mA
Color Temperature	Тс	2550	2700	2850	K	IF=60mA

# Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Rating	Units
Power Dissipation	Pd	240	MW
DC Forward Current	IF	80	mA
Peak Forward Current [1]	IFP	100	mA
Reverse Voltage	VR	5	V
Electrostatic Discharge (HBM)	ESD	4000	V
Operating Temperature	Topr	-30~+85	°C
Storage Temperature	Tstg	-40~+100	°C

#### Note:

- 1. 1/10 Dut cycle,0.1ms pulse width.
- 2. The above forward voltage measure ment allowance tolerance  $\pm 0.1 V$ .
- 3. 5000K above Color temperature product Color temperature allow differences  $\pm 100 K$ .
- 4. Colour rendering index allow differences -1 Ra.

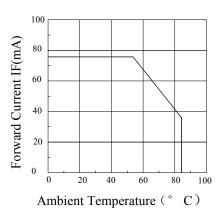
REV NO: A/1 Page :2 of 7

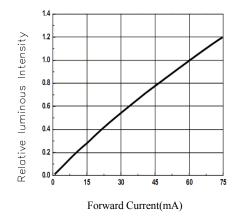


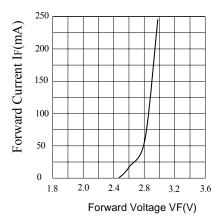


# Typical optical characteristics curves

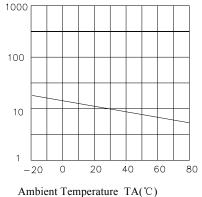
### Ambient Temperature VS. Forward Current



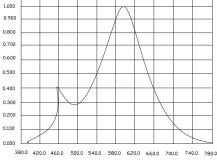




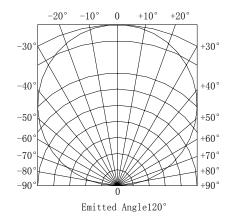
Relative luminous Intensity



1.100



Wavelength  $\lambda$  (nm)

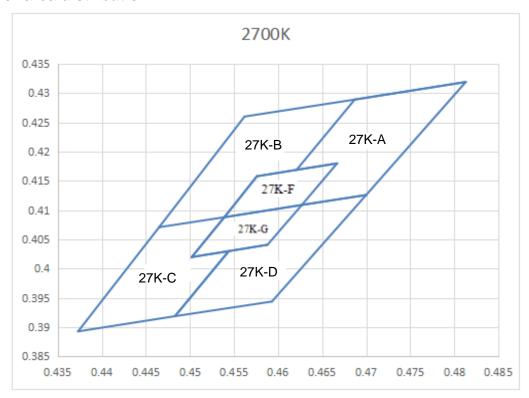


REV NO: A/1 Page :3 of 7





### Color area distribution



CCT	2700K		CCT	2700K	
BIN	X	Y	BIN	X	Y
	0.4813	0.4319		0.4465	0.4071
	0.4687	0.4289		0.4373	0.3893
27K-A	0.4621	0.4169	27K-C	0.4483	0.3919
2/K-A	0.4667	0.418	2/K-C	0.4544	0.403
	0.4627	0.4109		0.4502	0.402
	0.47	0.4126		0.4539	0.4088
	0.4813	0.4319			
	0.4687 0.4289		0.47	0.4126	
	0.4562	0.426		0.4627	0.4109
27K-B	0.4465	0.4071	45TC D	0.4588	0.4041
2/K-B	0.4539	0.4088	27K-D	0.4544	0.403
	0.4576	0.4158		0.4483	0.3919
	0.4621	0.4169		0.4593	0.3944
				0.47	0.4126
	0.4667	0.418	27K-G	0.4627	0.4109
27K-F	0.4576	0.4158		0.4539	0.4088
2/K-F	0.4539	0.4088		0.4502	0.402
	0.4627	0.4109		0.4588	0.4041

REV NO: A/1 Page :4 of 7





# **Reliability Test Items And Conditions**

The reliability of products shall be satisfied with items listed below.

Confidence level :90%

LTPD:10%

Test Items	Test conditions	Quantity	Judging Criteria
Thermal Shock Followed by High Temperature And High Humidity Cyclic	-40°→10min 5 Cycles ↑ ↓ shift(2~3)min 100°C →10 min. ≜ 25°C~55°C (90%~95%) RH 2 Cycles for 48 hrs., Recover for 2 hrs	11	C=0 & I**
Resistance For Soldering Heat	Reflow Soldering	15	C=0 & I**
DC Operating Life	1000 hrs. Forward Current: 60mA	22	C=0 & I**
High Temperature Storage	100°C	15	C=0 & I**
High Temperature And High Humidity Cyclic  And High Humidity Cyclic  Cycles for 144 hrs., Recover for 2 hrs.		11	C=0 & I**

The thchnical iformation shown in the data sheets are limited to the typical characteristics and circuit examples of the referenced products. It does not constitute the warranting of industrial property nor the granting of any license.

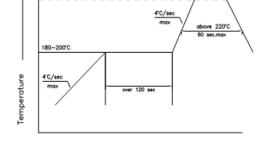
REV NO: A/1 Page 5 of 7





### **SMT Reflow Soldering Instructions**

- 1.Reflow soldering should not be done more than two times.
- 2.When soldering, do not put stress on the LEDs during heating.



Time

CL-SFC281DWW-3K-90CRI

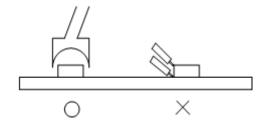
3.Product is highest resistant to 260°C, reflow but suggested the highest temperature of 240°C within .

### Soldering iron

- 2. The hand solder should be done only one times

### Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of LEDs will or will not be damaged by repairing.



#### **Cautions**

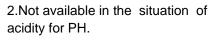
Therefore the LEDs have a soft surface on the top of package. The pressure to the top surface will be influence to the reliability of the LEDs. Precautions should be taken to avoid the strong pressure on the encapsulated part. So when use the picking up nozzle, the pressure on the silicone resin should be proper.

#### storage

- 1.Recommended storage condition:At 5°C~30°C and relative humidity 60% RH max.
- 2. After this bag is opened, devices that will be applied to infrared reflow, vapor-phase reflow,
- a.Completed within 24 hours.
- b.Stored at less than 30% RH.
- 3. Devices require baking before mounting, if: 2a or 2b is not met.
- 4.If baking is required, devices must be baked under below conditions 12 hours at 60°C±3°C.
- 5.It is recommended that SMD out of their original packaging are used within one year.
- 6. Open the packing Within 24 hours has not used up, need anew bake packaging.

### **Handling Precautions**

1.Do not stack together assembled PCBs containing LEDs. Impact may scratch the silicone lens or damage.





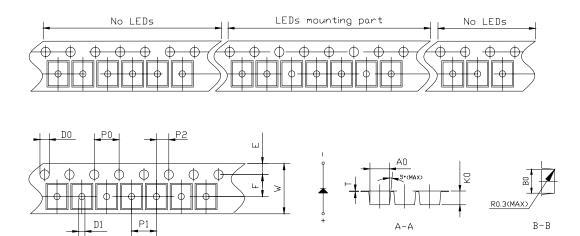


REV NO: A/1 Page :6 of 7



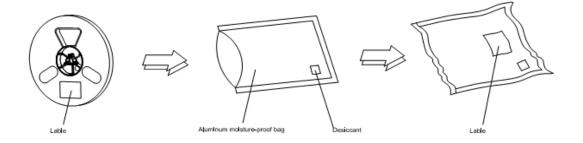


### Carrier tape



All dimensions in mm, tolerances unless mentioned is ±0.1 mm.

# **Moisture Resistant Packaging**



REV NO: A/1 Page :7 of 7